

TPS3705-30, TPS3705-33, TPS3705-50
TPS3707-25, TPS3707-30, TPS3707-33, TPS3707-50
PROCESSOR SUPERVISORY CIRCUITS WITH POWER-FAIL

SLVS184B – NOVEMBER 1998 – REVISED JANUARY 1999

features

- Power-On Reset Generator with Fixed Delay Time of 200 ms, no External Capacitor Needed
- Precision Supply Voltage Monitor 2.5 V, 3 V, 3.3 V, and 5 V
- Pin-For-Pin Compatible with the MAX705 through MAX708 Series
- Integrated Watchdog Timer (TPS3705 only)
- Voltage Monitor for Power-Fail or Low-Battery Warning
- Maximum Supply Current of 50 μ A
- MSOP-8 and SO-8 Packages
- Temperature Range . . . -40°C to 85°C

typical applications

- Designs Using DSPs, Microcontrollers or Microprocessors
- Industrial Equipment
- Programmable Controls
- Automotive Systems
- Portable/Battery Powered Equipment
- Intelligent Instruments
- Wireless Communication Systems
- Notebook/Desktop Computers

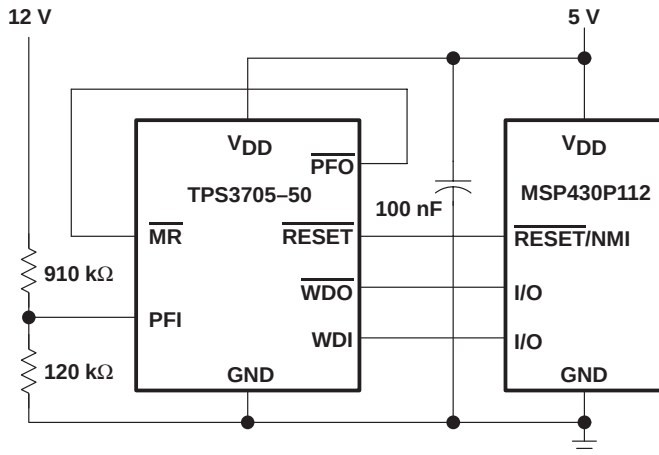
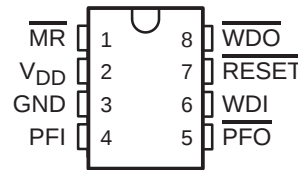
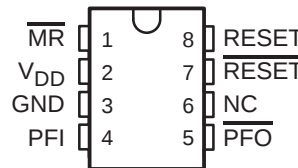


Figure 1. Typical MSP430 Application

**TPS3705 . . . D PACKAGE
(TOP VIEW)**

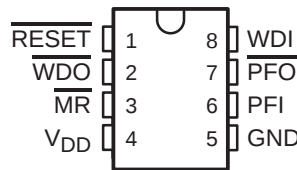


**TPS3707 . . . D PACKAGE
(TOP VIEW)**

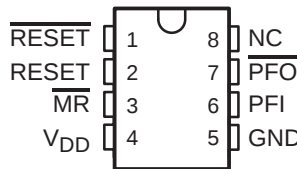


NC – No internal connection

**TPS3705 . . . DGN PACKAGE
(TOP VIEW)**



**TPS3707 . . . DGN PACKAGE
(TOP VIEW)**



NC – No internal connection



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**TEXAS
INSTRUMENTS**

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TPS3705-30, TPS3705-33, TPS3705-50
TPS3707-25, TPS3707-30, TPS3707-33, TPS3707-50
PROCESSOR SUPERVISORY CIRCUITS WITH POWER-FAIL
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description

The TPS3705, TPS3707 family of microprocessor supply-voltage supervisors provide circuit initialization and timing supervision, primarily for DSP and processor-based systems.

During power-on, $\overline{\text{RESET}}$ is asserted when the supply voltage V_{DD} becomes higher than 1.1 V. Thereafter, the supply voltage supervisor monitors V_{DD} and keeps $\overline{\text{RESET}}$ active as long as V_{DD} remains below the threshold voltage V_{IT+} . An internal timer delays the return of the output to the inactive state (high) to ensure proper system reset. The delay time, $t_{dtyp} = 200$ ms, starts after V_{DD} has risen above the threshold voltage V_{IT+} . When the supply voltage drops below the threshold voltage V_{IT-} , the output becomes active (low) again. No external components are required. All the devices of this family have a fixed-sense threshold voltage V_{IT-} set by an internal voltage divider.

The TPS3705-xx and TPS3707-xx devices incorporate a manual reset input, $\overline{\text{MR}}$. A low level at $\overline{\text{MR}}$ causes $\overline{\text{RESET}}$ to become active.

The TPS370x-xx families integrate a power-fail comparator which can be used for low-battery detection, power-fail warning, or for monitoring a power supply other than the main supply.

The TPS3705-xx devices have a watchdog timer that is periodically triggered by a positive or negative transition at WDI. When the supervising system fails to retrigger the watchdog circuit within the time-out interval, $t_{t(out)} = 1.6$ s, $\overline{\text{WDO}}$ becomes active. This event also reinitializes the watchdog timer. Leaving WDI unconnected disables the watchdog.

The TPS3707-xx devices do not have the Watchdog function, but include a high-level output RESET.

The product spectrum is designed for supply voltages of 2.5 V, 3 V, 3.3 V, and 5 V. The circuits are available in either 8-pin MSOP or standard SOIC packages. The TPS3705, TPS3707 devices are characterized for operation over a temperature range of -40°C to 85°C .

AVAILABLE OPTIONS

T _A	THRESHOLD VOLTAGE	PACKAGED DEVICES		MARKING DGN PACKAGE	CHIP FORM (Y)
		SMALL OUTLINE (D)	POWER-PAD™ μ-SMALL OUTLINE (DGN)		
-40°C to 85°C	2.63 V	TPS3705-30D	TPS3705-30DGN	TIAAT	TPS3705-30Y
	2.93 V	TPS3705-33D	TPS3705-33DGN	TIAAU	TPS3705-33Y
	4.55 V	TPS3705-50D	TPS3705-50DGN	TIAAV	TPS3705-50Y
	2.25 V	TPS3707-25D	TPS3707-25DGN	TIAAW	TPS3707-25Y
	2.63 V	TPS3707-30D	TPS3707-30DGN	TIAAX	TPS3707-30Y
	2.93 V	TPS3707-33D	TPS3707-33DGN	TIAAY	TPS3707-33Y
	4.55 V	TPS3707-50D	TPS3707-50DGN	TIAAZ	TPS3707-50Y

Function Tables

TRUTH TABLE, TPS3705

$\overline{\text{MR}}$	$V_{\text{DD}} > V_{\text{IT}}$	$\overline{\text{RESET}}$	TYPICAL DELAY
H→L	1	H→L	30 ns
L→H	1	L→H	200 ms
H	1→0	H→L	3 μs
H	0→1	L→H	200 ms

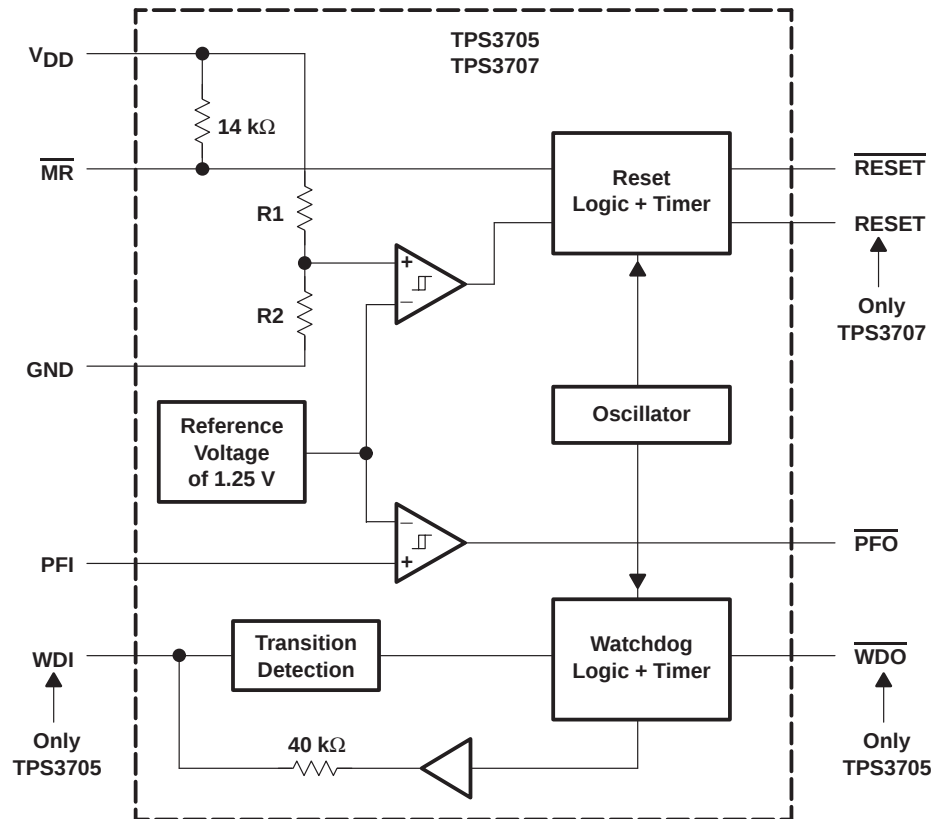
TRUTH TABLE, TPS3707

$\overline{\text{MR}}$	$V_{\text{DD}} > V_{\text{IT}}$	$\overline{\text{RESET}}$	RESET	TYPICAL DELAY
H→L	1	H→L	L→H	30 ns
L→H	1	L→H	H→L	200 ms
H	1→0	H→L	L→H	3 μs
H	0→1	L→H	H→L	200 ms

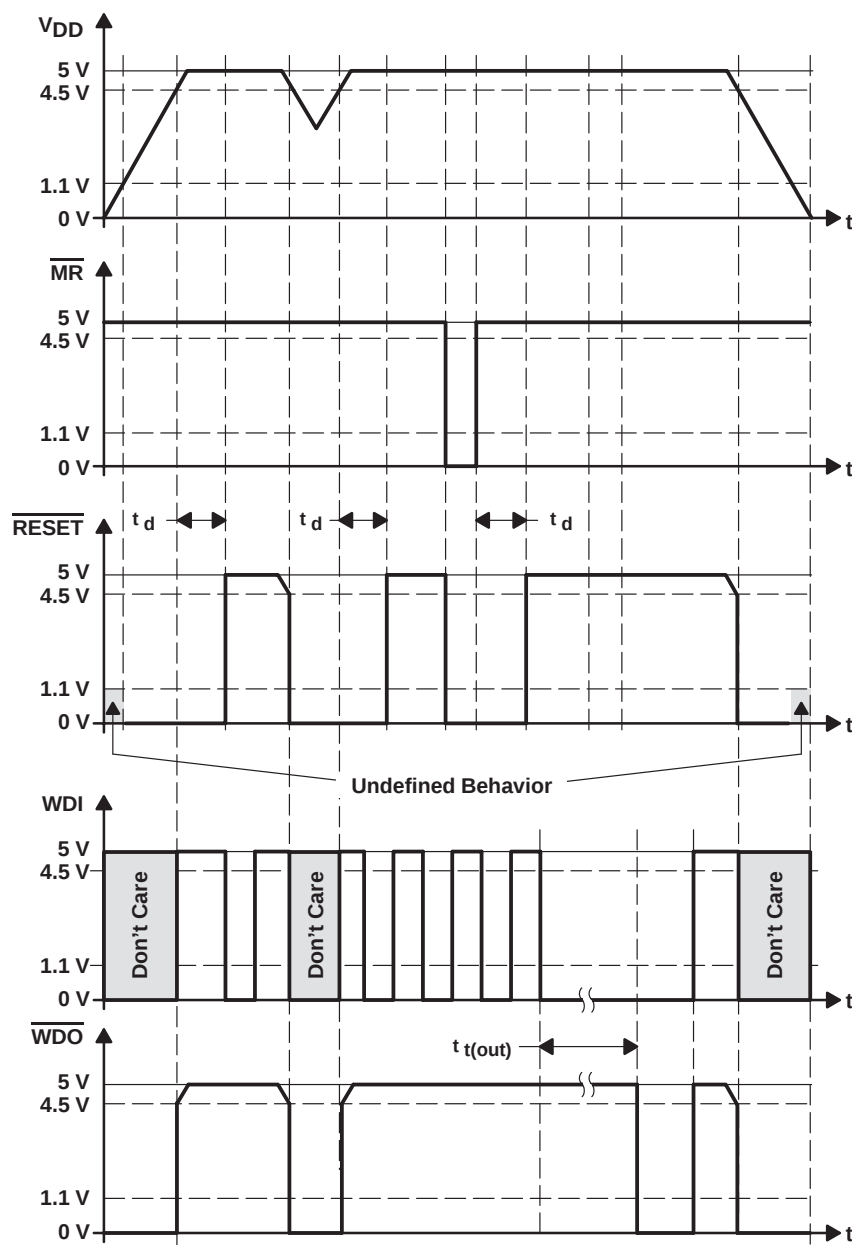
TRUTH TABLE, TPS370x

$\text{PFI} > V_{\text{IT}}$	$\overline{\text{PFO}}$	TYPICAL DELAY
0→1	L→H	0.5 μs
1→0	H→L	0.5 μs

functional block diagram

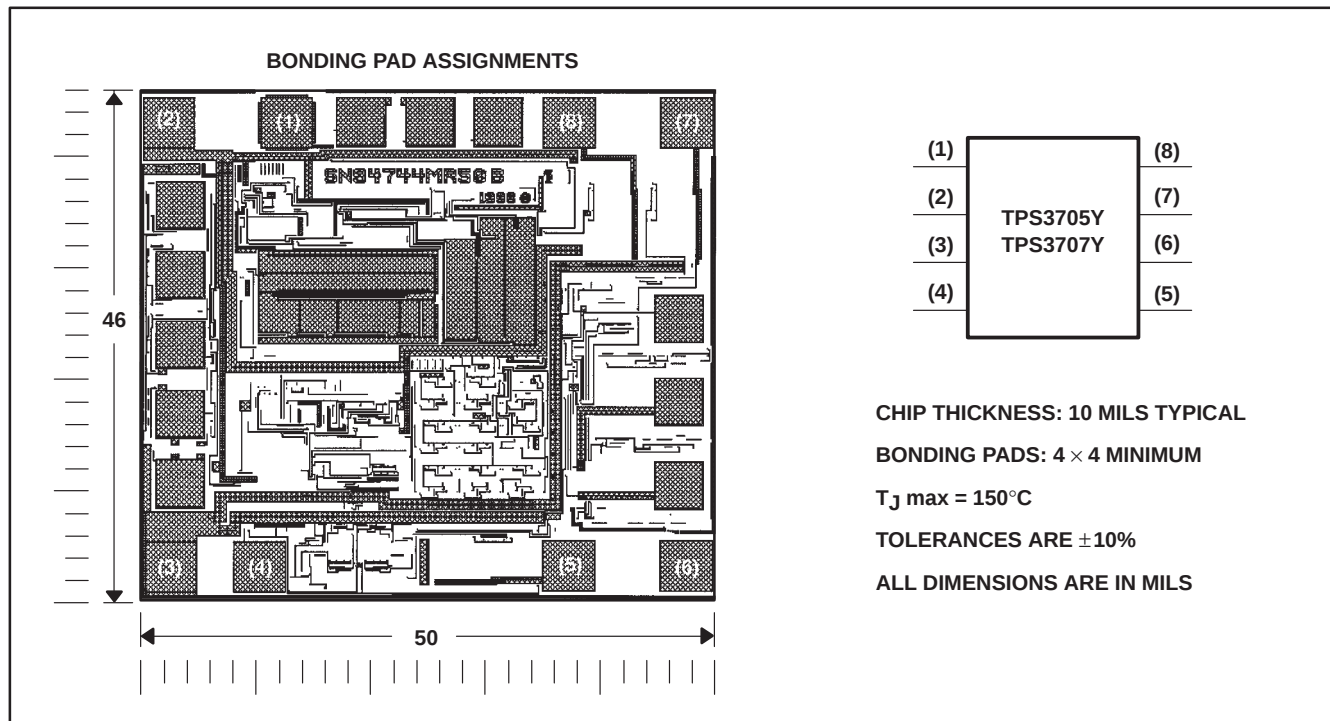


timing diagrams



TPS370xY chip information

These chips, when properly assembled, display characteristics similar to those of the TPS370x. Thermal compression or ultrasonic bonding may be caused on the doped-aluminum bonding pads. The chips may be mounted with conductive epoxy or a gold-silicon preform.



Terminal Functions

TERMINAL		NO.	I/O	DESCRIPTION
NAME				
MR		1	I	Manual reset
VDD		2		Supply voltage
GND		3		Ground
PFI		4	I	Power-fail comparator input
PFO		5	O	Power-fail comparator output
WDI	TPS3705	6	I	Watchdog timer input
NC	TPS3707			No internal connection
RESET		7	O	Active-low reset output
WDO	TPS3705	8	O	Watchdog timer output
RESET	TPS3707		O	Active-high reset output

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absolute maximum ratings over operating free-air temperature (unless otherwise noted)[†]

Supply voltage, V_{DD} (see Note1)	7 V
All other pins (see Note 1)	–0.3 V to 7 V
Maximum low output current, I_{OL}	5 mA
Maximum high output current, I_{OH}	–5 mA
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{DD}$)	± 20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{DD}$)	± 20 mA
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A	–40°C to 85°C
Storage temperature range, T_{stg}	–65°C to 150°C
Soldering temperature	260°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute–maximum–rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND. For reliable operation the device must not be operated at 7 V for more than $t = 1000$ h continuously.

DISSIPATION RATING TABLE

PACKAGE	$T_A < 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING
DGN	2.14 W	17.1 mW/°C	1.37 W	1.11 W
D	725 mW	5.8 mW/°C	464 mW	377 mW

recommended operating conditions at specified temperature range

	MIN	MAX	UNIT
Supply voltage, V_{DD}	2	6	V
Input voltage, V_I	0	$V_{DD} + 0.3$	V
High-level input voltage, V_{IH}	$0.7 \times V_{DD}$		V
Low-level input voltage, V_{IL}		$0.3 \times V_{DD}$	V
Input transition rise and fall rate at MR or WDI, $\Delta t / \Delta V$		100	ns/V
Operating free-air temperature range, T_A	–40	85	°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
V_{OH}	High-level output voltage	TPS370x-xx	$V_{DD} = 1.1\text{ V}$ $I_{OH} = -4\text{ }\mu\text{A}$	0.8			V
		TPS3707-25	$V_{DD} = V_{IT+} + 0.2\text{ V}$, $I_{OH} = -500\text{ }\mu\text{A}$	$0.7 \times V_{DD}$			
		TPS370x-30					
		TPS370x-33	$V_{DD} = V_{IT+} + 0.2\text{ V}$, $I_{OH} = -800\text{ }\mu\text{A}$	$V_{DD} - 1.5\text{ V}$			
		TPS370x-50					
V_{OL}	Low-level output voltage	TPS370x-xx	$V_{DD} = 6\text{ V}$, $I_{OH} = -800\text{ }\mu\text{A}$				V
		TPS3707-25	$V_{DD} = V_{IT+} + 0.2\text{ V}$, $I_{OL} = 1\text{ mA}$		0.3		
		TPS370x-30					
		TPS370x-33					
		TPS370x-50	$V_{DD} = V_{IT+} + 0.2\text{ V}$, $I_{OL} = 2.5\text{ mA}$			0.4	
Power-up reset voltage (see Note 2)		TPS370x-xx	$V_{DD} = 6\text{ V}$ $I_{OL} = 3\text{ mA}$				V
		TPS3707-25	$V_{DD} \geq 1.1\text{ V}$, $I_{OL} = 50\text{ }\mu\text{A}$		0.3		
		TPS370x-30					
		TPS370x-33					
		TPS370x-50					
V_{IT-}	Negative-going input threshold voltage (see Note 3)	TPS3707-25	$T_A = 0^\circ\text{C to } 85^\circ\text{C}$	2.20	2.25	2.30	V
		TPS370x-30		2.57	2.63	2.68	
		TPS370x-33		2.87	2.93	2.98	
		TPS370x-50		4.45	4.55	4.63	
		TPS3707-25	$T_A = -40^\circ\text{C to } 85^\circ\text{C}$	2.20	2.25	2.32	V
		TPS370x-30		2.57	2.63	2.70	
		TPS370x-33		2.87	2.93	3.0	
		TPS370x-50		4.45	4.55	4.65	
		PFI	$V_{DD} \geq 2\text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$	1.20	1.25	1.30	V
V_{hys}	Hysteresis	TPS3707-25	V_{DD}		40		mV
		TPS370x-30			50		
		TPS370x-33			50		
		TPS370x-50			70		
		PFI	TPS370x-xx		10		
$I_{IH(AV)}$	Average high-level input current	WDI		$WDI = V_{DD} = 6\text{ V}$, Time average (dc = 88%)		100 150	μA
$I_{IL(AV)}$	Average low-level input current			$WDI = 0\text{ V}$, $V_{DD} = 6\text{ V}$, Time average (dc = 12%)		-15 -20	μA
I_{IH}	High-level input current	WDI		$WDI = V_{DD} = 6\text{ V}$		120 170	μA
		MR		$MR = 0.7 \times V_{DD}$, $V_{DD} = 6\text{ V}$		-130 -180	
I_{IL}	Low-level input current	WDI		$WDI = 0\text{ V}$, $V_{DD} = 6\text{ V}$		-120 -170	μA
		MR		$MR = 0\text{ V}$, $V_{DD} = 6\text{ V}$		-430 -600	
I_I	Input current	PFI		$V_{DD} = 6\text{ V}$, $0\text{ V} \leq V_I \leq V_{DD}$		-1 0 1	μA
I_{DD}	Supply current	TPS3707-xx	$V_{DD} = 2\text{ V to } 6\text{ V}$, $MR = V_{DD}$, MR , WDI and outputs unconnected		20	50	μA
		TPS3705-xx	$V_{DD} = 2\text{ V to } 6\text{ V}$, $MR = V_{DD}$, MR , WDI and outputs unconnected		30	50	μA
C_i	Input capacitance		$V_I = 0\text{ V to } V_{DD}$		5		pF

- NOTES: 2. The lowest supply voltage at which RESET becomes active. $t_r, V_{DD} \geq 15\text{ }\mu\text{s/V}$
 3. To ensure best stability of the threshold voltage, a bypass capacitor (ceramic, 0.1 μF) should be placed near to the supply terminals.

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timing requirements at $R_L = 1\text{ M}\Omega$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_W	Pulse width	at V_{DD} $V_{DD} = V_{IT+} + 0.2\text{ V}$, $V_{DD} = V_{IT-} - 0.2\text{ V}$	6			μs
		at $\overline{\text{MR}}$ $V_{DD} \geq V_{IT+} + 0.2\text{ V}$, $V_{IL} = 0.3 \times V_{DD}$, $V_{IH} = 0.7 \times V_{DD}$	100			ns
		at WDI $V_{DD} \geq V_{IT+} + 0.2\text{ V}$, $V_{IL} = 0.3 \times V_{DD}$, $V_{IH} = 0.7 \times V_{DD}$	100			ns

switching characteristics at $R_L = 1\text{ M}\Omega$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{t(\text{out})}$	Watchdog time out	$V_{DD} \geq V_{IT+} + 0.2\text{ V}$, See timing diagram	1.1	1.6	2.3	s
t_d	Delay time	$V_{DD} > V_{IT+} + 0.2\text{ V}$, See timing diagram	140	200	280	ms
t_{PHL}	Propagation (delay) time, high-to-low-level output	$\overline{\text{MR}}$ to $\overline{\text{RESET}}$ delay			50	250
t_{PLH}	Propagation (delay) time, low-to-high-level output	$\overline{\text{MR}}$ to $\overline{\text{RESET}}$ delay (TPS3707-xx only)			50	250
t_{PHL}	Propagation (delay) time, high-to-low-level output	V_{DD} to $\overline{\text{RESET}}$ delay			3	5
t_{PLH}	Propagation (delay) time, low-to-high-level output	V_{DD} to $\overline{\text{RESET}}$ delay (TPS3707-xx only)			3	5
t_{PHL}	Propagation (delay) time, high-to-low-level output	PFI to $\overline{\text{PFO}}$ delay			0.5	1
t_{PLH}	Propagation (delay) time, low-to-high-level output				0.5	1

TYPICAL CHARACTERISTICS

NORMALIZED INPUT THRESHOLD VOLTAGE VS FREE-AIR TEMPERATURE AT V_{DD}

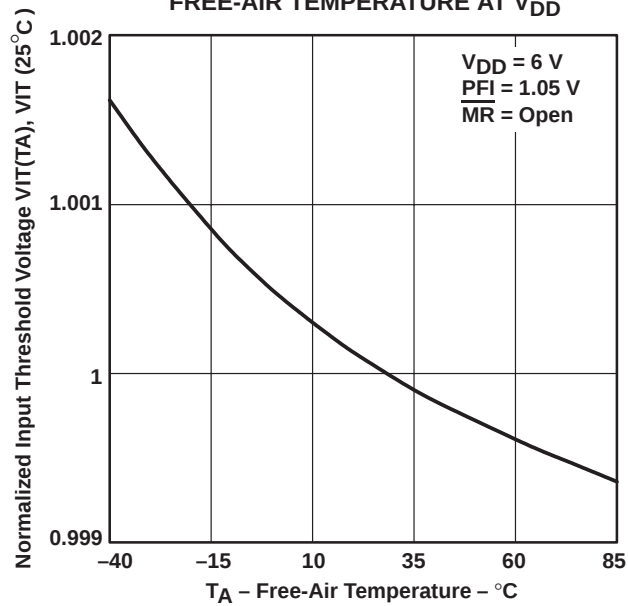


Figure 2

SUPPLY CURRENT VS SUPPLY VOLTAGE

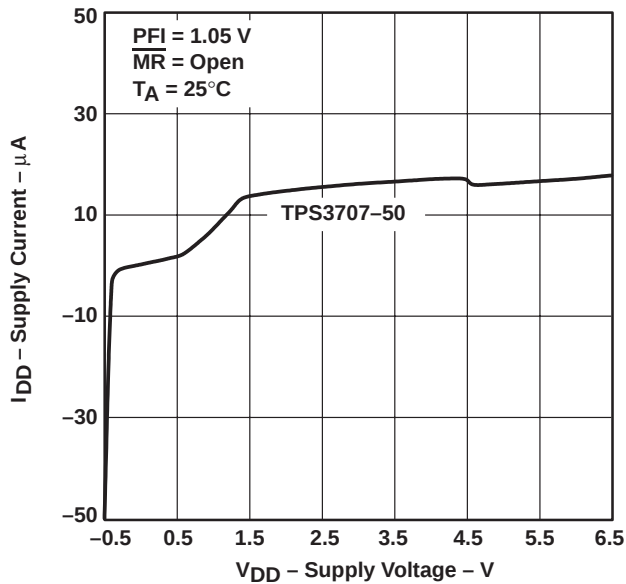


Figure 3

INPUT CURRENT VS INPUT VOLTAGE AT $\overline{MR}$

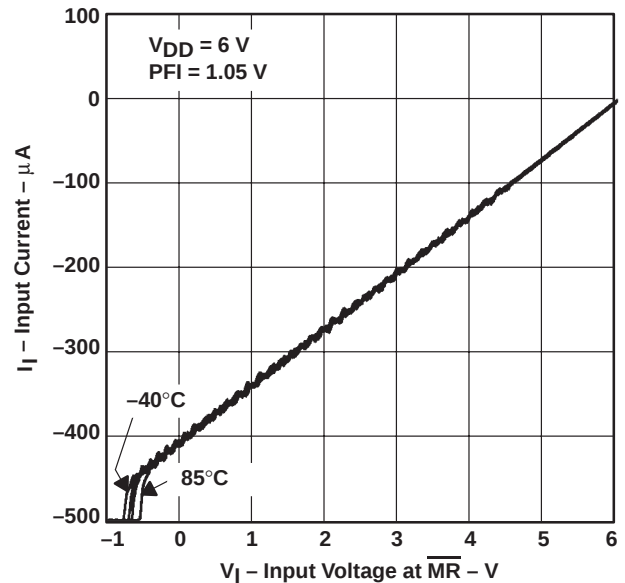


Figure 4

TYPICAL CHARACTERISTICS

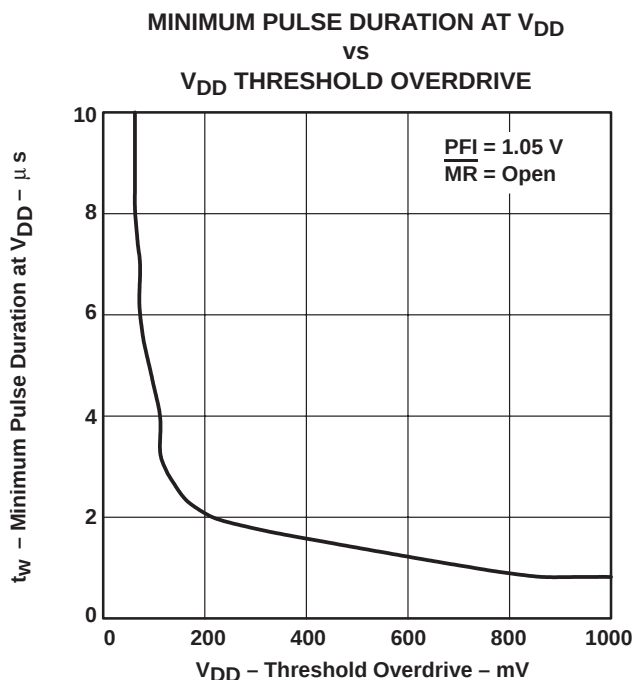


Figure 5

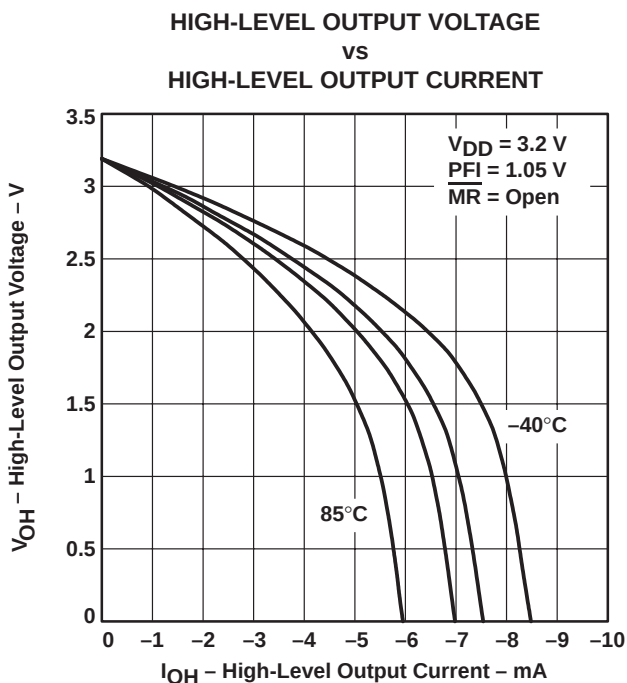


Figure 6

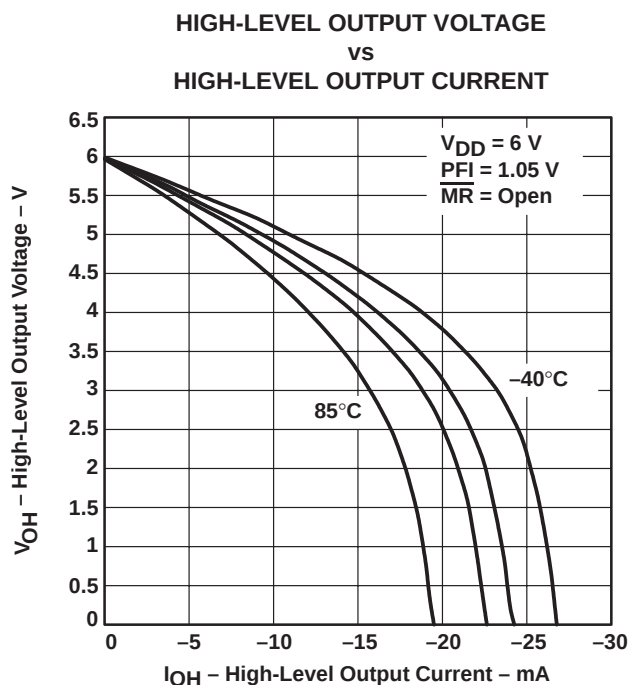


Figure 7

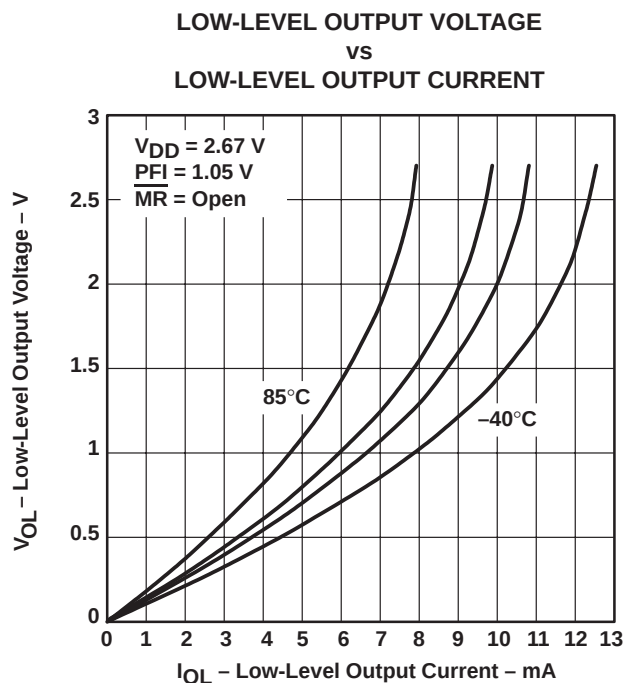


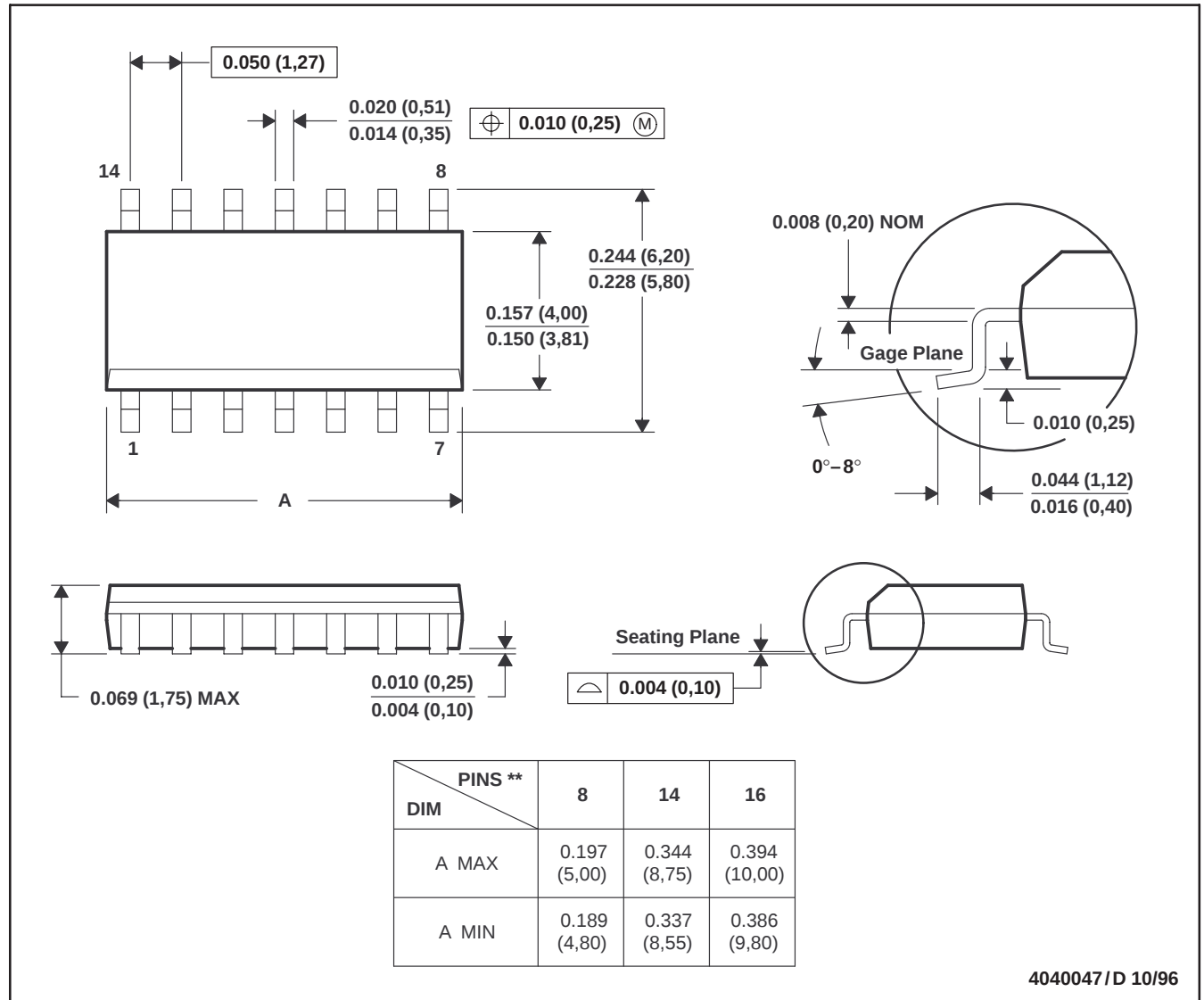
Figure 8

MECHANICAL DATA

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PIN SHOWN

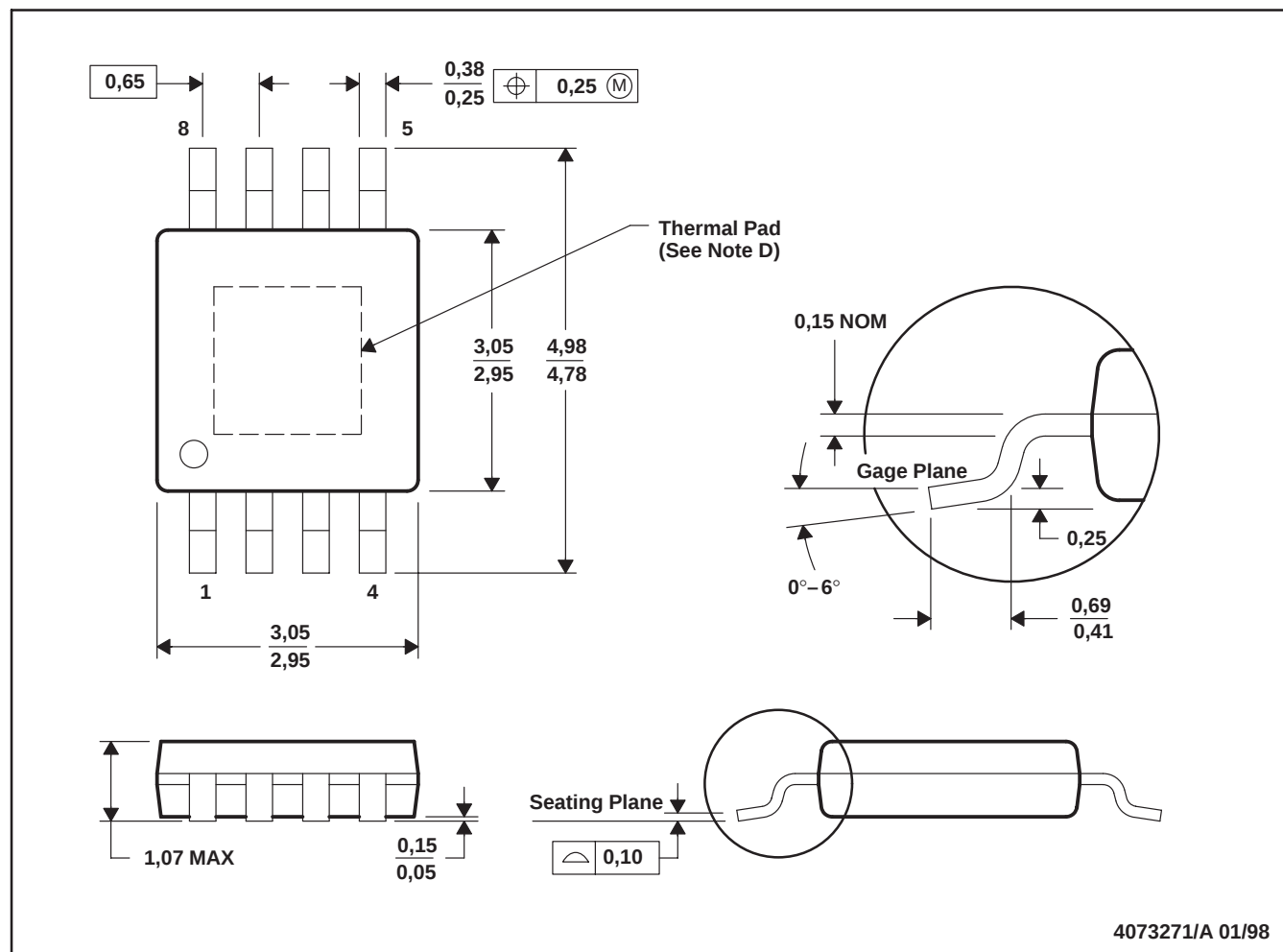


- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-012

MECHANICAL DATA

DGN (S-PDSO-G8)

PowerPAD™ PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions include mold flash or protrusions.
 D. The package thermal performance may be enhanced by attaching an external heat sink to the thermal pad. This pad is electrically and thermally connected to the backside of the die and possibly selected leads.
 E. Falls within JEDEC MO-187

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